

S	SPECIFICATIONS	
CUSTOMER	:	
SAMPLE CODE	SH800480T0	30-ZHA01
MASS PRODUCTION CODE	PH800480T0	30-ZHA01
SAMPLE VERSION	02	
SPECIFICATIONS EDITION	005	
DRAWING NO. (Ver.)	LMD-PH8004	80T030-ZHA01(Ver.003)
PACKAGING NO. (Ver.)	PKG- PH8004	480T030-ZHA01(Ver.001)
Cı		Date:
		Date:
Approved	Checked	Date: Designer
Approved 廖志豪	Checked 張慶源	Designer 陳宗淇
Approved 廖志豪 Rex Liao	Checked 張慶源 Yuan Chang	Designer 陳宗淇 Howard Chen
Approved         廖志豪         Rex Liao         □       Preliminary specification for Specification for sample app	Checked 張慶源 Yuan Chang	Designer 陳宗淇 Howard Chen
Approved         廖志豪         Rex Liao         □       Preliminary specification for Specification for sample approximation	Checked 張慶源 Yuan Chang or design input proval	Designer 陳宗淇 Howard Chen



# **History of Version**

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
05/09/2019	01	001	New Drawing.	-	Howard
11/05/2019	01	002	Add Surface treatment Modify Backlight Characteristics Modify CS/ID1,SDIN/ID2,SCK/ID3 Description Modify FPC suggested connector	4 9 12 Appendix	Howard
04/19/2020	02	003	Second Sample Modify System Bus Timing for RGB Interface Modify SYNC-DE Mode Add Kapton tape According to customer request modify Contents	14 16 Appendix -	Howard
04/24/2020	02	004	According to customer request modify Contents	Appendix	Howard
05/14/2020	02	005	LCD Type From IPS modify to Full Viewing Angle	4	Howard
		X			



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## **1. SPECIFICATIONS**

## **1.1 Features**

<u>Item</u>	Standard Value
Display Resolution	800 * 3 (RGB) * 480 Dots
LCD Type	Full Viewing Angle, Normally Black, Transmissive type
Screen size(inch)	5.0 inch
Surface treatment	Anti-Glare
Color configuration	RGB Vertical Strip
Backlight Type	White LED B/L
Weight	60g
Interface	Parallel RGB (Data), SPI (Configuration)
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer website :
	http://www.powertip.com.tw/news_detail.php?Key=1&cID=1

# 1.2 Mechanical Specifications

<u>Item</u>	Standard Value	<u>Unit</u>
Outline Dimension	121.0(W) x 75.9(L) x 3.1(H)	mm

#### LCD panel

<u>ltem</u>	Standard Value	<u>Unit</u>
Active Area	108.0 (W) x 64.8(L)	mm

Note: For detailed information please refer to LCM drawing



## **1.3 Absolute Maximum Ratings**

#### Module

<u>Item</u>	<u>Symbol</u>	<b>Condition</b>	<u>Min.</u>	<u>Max.</u>	<u>Unit</u>	<u>Remark</u>
Power Supply for TFT Panel	VDD	GND=0	-0.3	4.5	V	
Power Supply for Backlight Unit	VCC	GND=0	-0.3	+20.0	V	-
Operating Temperature	Top (Ts)	Note 1	-20	70	°C	
Storage Temperature	T <sub>ST</sub> (Ta)	Note 2	-30	80	°C	

The absolute maximum rating values of this product are not allowed to be exceeded at any time. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

Note 1: Ts is the temperature of panel's surface

Note 2: Ta is the ambient temperature of samples

## **1.4 DC Electrical Characteristics**

#### Module

GND = 0V, Ta = 25°C

<u>ltem</u>	<u>Symbol</u>	<b>Condition</b>	<u>Min.</u>	<u>Typ.</u>	<u>Max.</u>	<u>Unit</u>
Power Supply for TFT Panel	VDD	GND=0V	3.0	3.3	3.6	V
Power Supply for Backlight Unit	VCC	GND=0V	5	12	15	V
Input Voltage for	Vін	GND=0V	0.7VDD	-	VDD	V
TFT Panel	Vil	GND=0V	0	-	0.3VDD	V
Supply Current for TFT Panel	IDD	IDD@VDD=3.3V	-	75	110	
Supply Current for Backlight Unit	ICC	ICC@VCC=5V	-	250	380	mA
Supply Current for Backlight Unit	ICC	ICC@VCC=12V	-	110	160	
Input Voltage for	VPH	GND=0V	1.2	-	-	V
PWM Signal	VPL	GND=0V	-	-	0.4	V
Dimming Clock Rate	fP	GND=0V	5	-	100	KHz



# **1.5 Optical Characteristics**

#### TFT LCD Module

VDD= 3.3 V, Ta=25°C

<u>Item</u>		<u>Symbol</u>	<b>Condition</b>	<u>Min.</u>	<u>Typ.</u>	Max.	<u>unit</u>	:
Response time	Tr+Tf		Ta = 25°C θX, θY = 0°	-	37	56	ms	Note 2
	Тор	θΥ+			80	-		
	Bottom	θY-	CD > 10		80	-	Deg	Noto 4
Viewing angle	Left	θΧ-	CR ≥ 10		80	-	Deg.	Note 4
	Right	θX+			80	-		
Contrast ratio		CR		650	800	-	-	Note 3
	\//bita	Х		0.25	0.30	0.35		
	White	Y		0.28	0.33	0.38		
	Ded	Х	T- 05%0	0.55	0.60	0.65		
Color of CIE	Red	Y	Ta = 25°C	0.30	0.35	0.40		Noto1
Coordinate (With B/L)	0	х	$\Theta X$ , $\Theta Y = 0^{\circ}$	0.30	0.35	0.40	-	Note1
	Green	Y		0.54	0.59	0.64		
	Dhia	Х		0.09	0.14	0.19		
	Blue	Y		0.05	0.10	0.15		
Average								
Brightness			VCC=12.0V					
Pattern=white		IV	PWM="High"	800	1000	-	cd/m2	Note1
display			(Duty=100%)					
(With LCD)*1								
Uniformity			VCC=12.0V					
(With LCD)*2		∆B	PWM="High"	70	-	-	%	Note1
			(Duty=100%)					



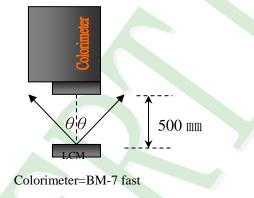
Note 1:

- \*1: △B=B(min) / B(max) \* 100%
- \*2: Measurement Condition for Optical Characteristics:

a: Environment:  $25^{\circ}C \pm 5^{\circ}C$  /  $60\pm 20^{\circ}R$ .H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency

- b: Measurement Distance: 500  $\pm$  50 mm, ( $\theta$ = 0°)
- c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation
- d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%

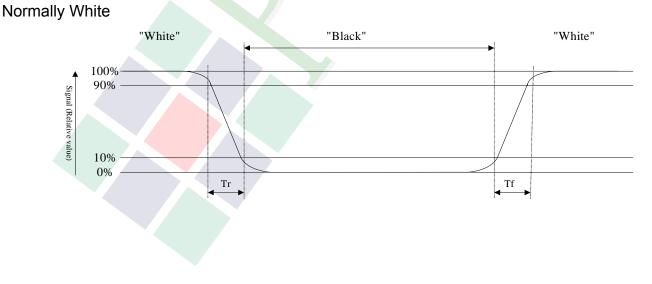




To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

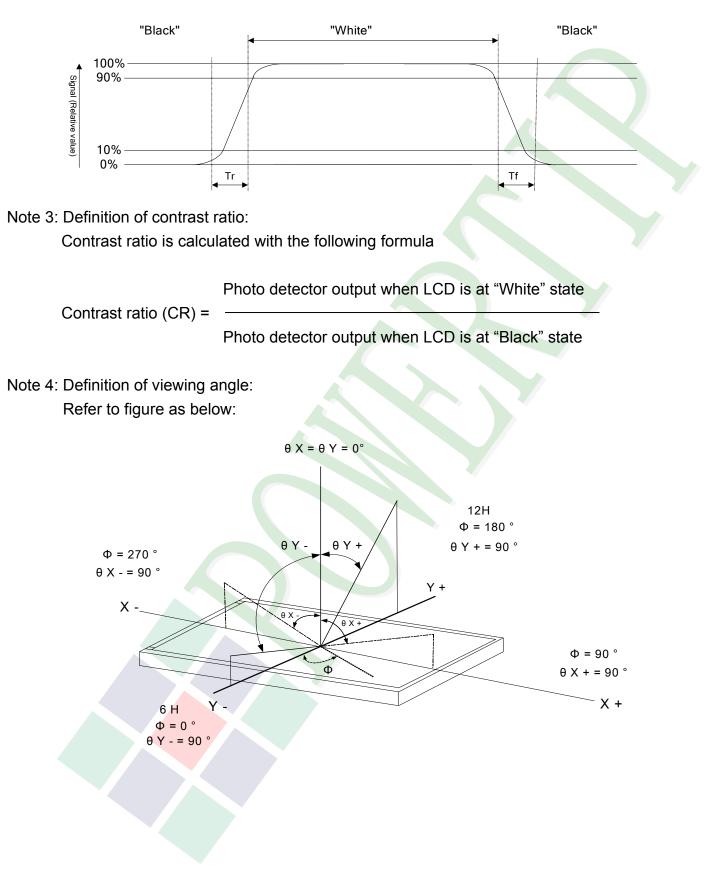
Note 2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes. Refer to figure as below:





Normally Black





## **1.6 Backlight Characteristics**

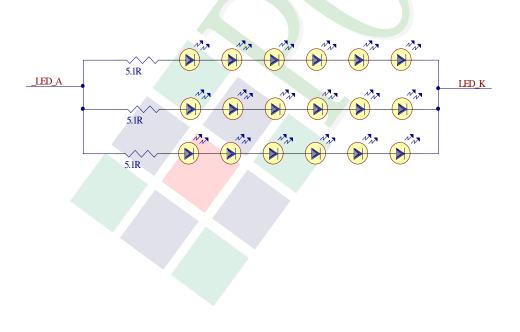
#### **Maximum Ratings**

<u>ltem</u>	<u>Symbol</u>	<u>Min.</u>	<u>Max.</u>	<u>Unit</u>	<u>Remark</u>
LED Forward Current	lF	-	25*3	mA	
LED Reverse Voltage	VR	-	5*6	V	-
Power Dissipation	PD		1500	mW	

#### **Electrical / Optical Characteristics**

ltem	<u>Symbol</u>	<u>Min.</u>	<u>Typ.</u>	<u>Max.</u>	<u>Unit</u>	<u>Remark</u>
LED Voltage	VL	18.0	19.0	ŀ	V	Note1
LED Current	١L		60	-	mA	-
LED life time	-	50,000	-	I	Hr	Note2

- Note 1: The LED Supply Voltage is defined by the number of LED at Ta=25<sup>°</sup>C and I∟=60 mA.
- Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25℃ and IL =60 mA. The LED life time could be decreased if operating IL is larger than 60 mA.





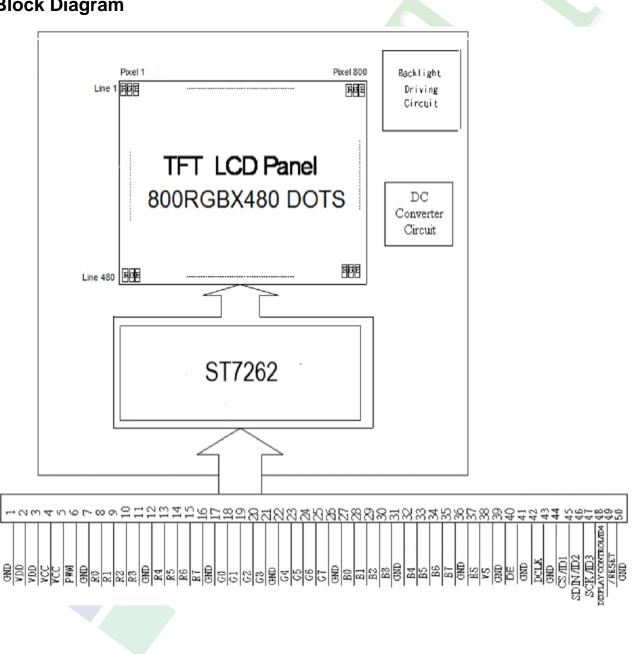
## 2. Module Structure

## 2.1 Counter Drawing

## 2.1.1 LCM Mechanical Diagram

\* See Appendix

#### 2.1.2 Block Diagram





# 2.2 Interface Pin Description

#### **TFT LCM Interface**

Pin#	<u>Name</u>	Description
1	GND	Power ground.
2	VDD	Power for Digital Circuit.
3	VDD	Power for Digital Circuit.
4	VCC	Power For LED backlight.
5	VCC	Power For LED backlight.
6	PWM	Shutdown & Dimming control input for backlight. Do not allow this pin to float. "Hi" =100%, "Low" = 0%.
7	GND	Power ground.
8	R0	Red Data.
9	R1	Red Data.
10	R2	Red Data.
11	R3	Red Data.
12	GND	Power ground.
13	R4	Red Data.
14	R5	Red Data.
15	R6	Red Data.
16	R7	Red Data.
17	GND	Power ground.
18	G0	Green Data.
19	G1	Green Data.
20	G2	Green Data.
21	G3	Green Data.
22	GND	Power ground.
23	G4	Green Data.
24	G5	Green Data.
25	G6	Green Data.
26	G7	Green Data.
27	GND	Power ground.
28	B0	Blue Data.
29	B1	Blue Data.



Pin#	<u>Name</u>	<u>Description</u>
30	B2	Blue Data.
31	B3	Blue Data.
32	GND	Power ground.
33	B4	Blue Data.
34	B5	Blue Data.
35	B6	Blue Data.
36	B7	Blue Data.
37	GND	Power ground.
38	HS	Line synchronization signal. Horizontal Sync Input.
39	VS	Frame synchronization signal. Vertical Sync Input.
40	GND	Power ground.
41	DE	Data Enable.
42	GND	Power ground.
43	DCLK	Sample clock. Data will be latched at the falling edge of DCLK.
44	GND	Power ground.
45	CS/ ID1	Serial communication chip selection/ID[4:1]These pins select LCM type. See NOTE1
46	SDIN/ ID2	Serial communication data/ ID[4:1]These pins select LCM type. See NOTE1
47	SCK/ ID3	Serial communication clock/ ID[4:1]These pins select LCM type. See NOTE1
48	DISPLAY CONTROL / ID4	Display Enable(Hi Active)./ ID[4:1]These pins select LCM type. See NOTE1
49	/RESET	Global Reset (Low Active).
50	GND	Power ground.

#### Note1:

ID Pins Definition:

	<u>PIN 45 ID1</u>	<u>PIN 46 ID2</u>	<u>PIN 47 ID3</u>	<u>PIN 48 ID3</u>
3.5" Module	Х	0	0	Х
4.3" Module	X	1	0	Х
5.0" Module	X	0	1	Х
7.0" Module	X	1	1	Х

1. Resistor = 10k ohm

2. "X" = No use



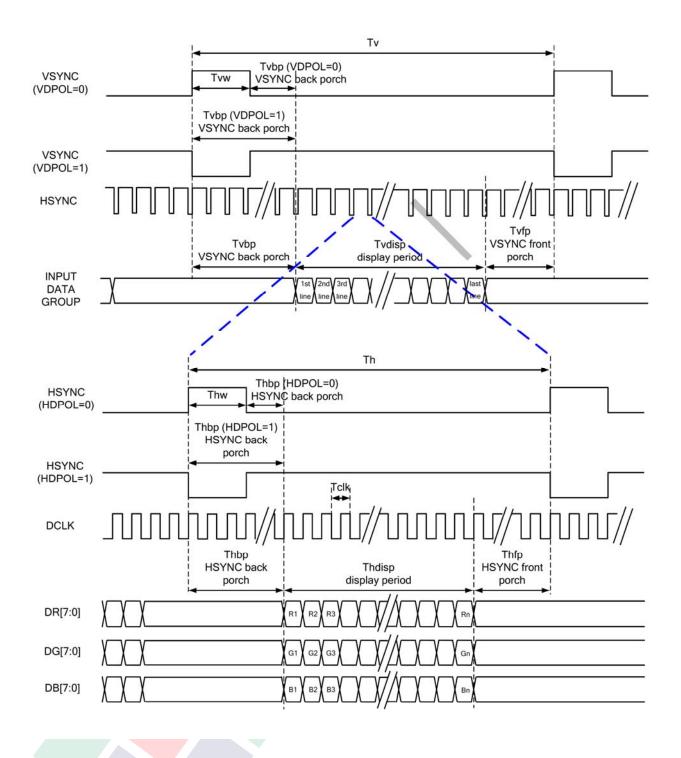
# 2.3 Timing Characteristics

## 2.3.1 RGB Mode Selection Table

RGB Mode Selection Table	<u>DCLK</u>	<u>HSYNC</u>	<u>VSYNC</u>	DE
SYNC - DE Mode	Input	Input	Input	Input
SYNC Mode	Input	Input	Input	GND
DE Mode	Input	GND	GND	Input

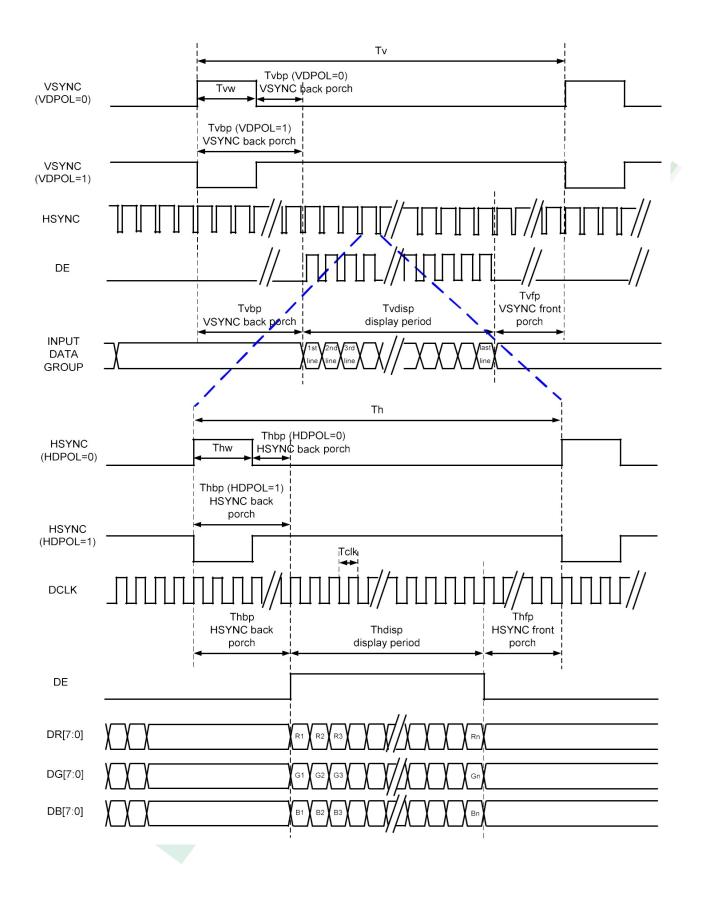


#### 2.3.2 Parallel RGB SYNC Mode



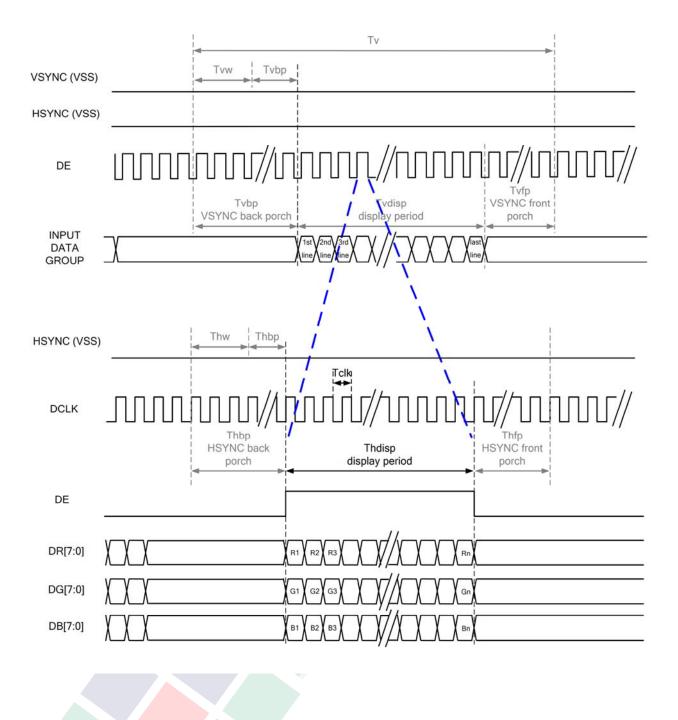


## 2.3.3 Parallel RGB SYNC-DE Mode





#### 2.3.4 Parallel RGB DE Mode



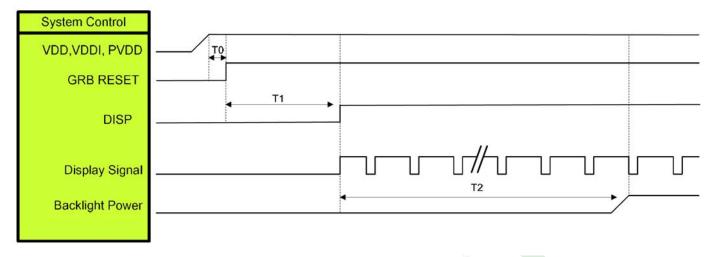


## 2.3.5 Parallel 24-bit RGB Input Timing Table

Parallel 24-bit RGB Interface Timing Table							
	<u>ltem</u>	<u>Symbol</u>	<u>Min.</u>	<u>Typ.</u>	<u>Max.</u>	<u>Unit</u>	<u>Remark</u>
DCLK	(Frequency	Fclk	23	25	27	MHz	
	Period Time	Th	808	816	896	DCLK	
	Display Period	Thdisp		800		DCLK	
HSYNC	Back Porch	Thbp	4	8	48	DCLK	
	Front Porch	Thfp	4	8	48	DCLK	
	Pulse Width	Thw	2	4	8	DCLK	
	Period Time	Τv	488	496	504	HSYNC	
	Display Period	Tvdisp		480		HSYNC	
VSYNC	Back Porch	Tvbp	4	8	12	HSYNC	
	Front Porch	Tvfp	4	8	12	HSYNC	
	Pulse Width	Tvw	2	4	8	HSYNC	



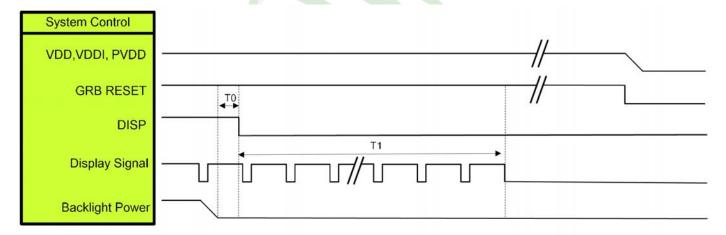
## 2.3.6 Power On Sequence



<u>Symbol</u>	Description	<u>Min. Time</u>	<u>Unit</u>
то	System power stability to GRB RESET signal	0	ms
T1	GRB RESET= "High" to DISP="High"	10	ms
T2	Display Signal output to Backlight Power on	250	ms

Note: RGB interface Display signal: DCLK; VSYNC; HSYNC; DE; DR[7:0]; DG[7:0]; DB[7:0] Note: LVDS interface Display signal: DCLK P/N; RX[3:0]P/N

### 2.3.7 Power Off Sequence

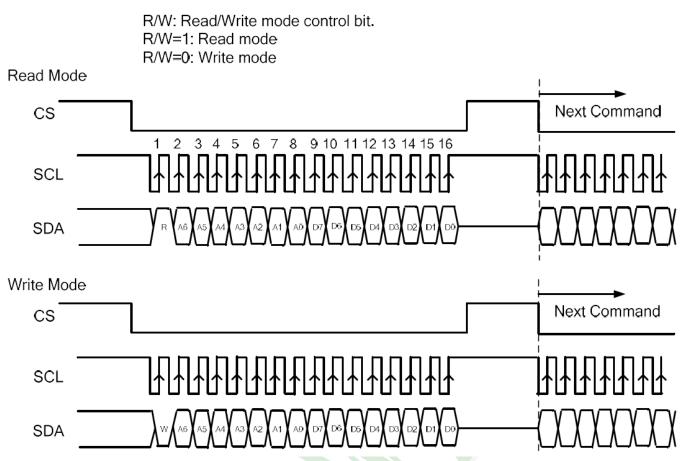


<u>Symbol</u>	<b>Description</b>	<u>Min. Time</u>	<u>Unit</u>
то	Backlight Power off to DISP="Low"	5	ms
T1	DISP="Low" to IC internal voltage discharge complete	100	ms

Note: RGB interface Display signal: DCLK; VSYNC; HSYNC; DE; DR[7:0]; DG[7:0]; DB[7:0] Note: LVDS interface Display signal: DCLK P/N; RX[3:0]P/N



## 2.4 3-wire Serial Interface (SPI)



**a.** Each serial command consists of 16 bits of data which is loaded one bit a time at the rising edge of serial clock SCL.

**b.** Common loading operation starts from the falling edge of CS and is completed at the next rising edge of CS.

**c.** The serial control block is operational after power on reset, but commands are established by the VSYNC signal. If command is transferred multiple times for the same register, the last command before the VSYNC signal is valid.

**d.** If less than 16 bits of SCL are input while CS is low, the transferred data is ignored.

**e.** If 16 bits or more of SCL are input while CS is low, the previous 16 bits of transferred data before then rising edge of CS pulse are valid data.

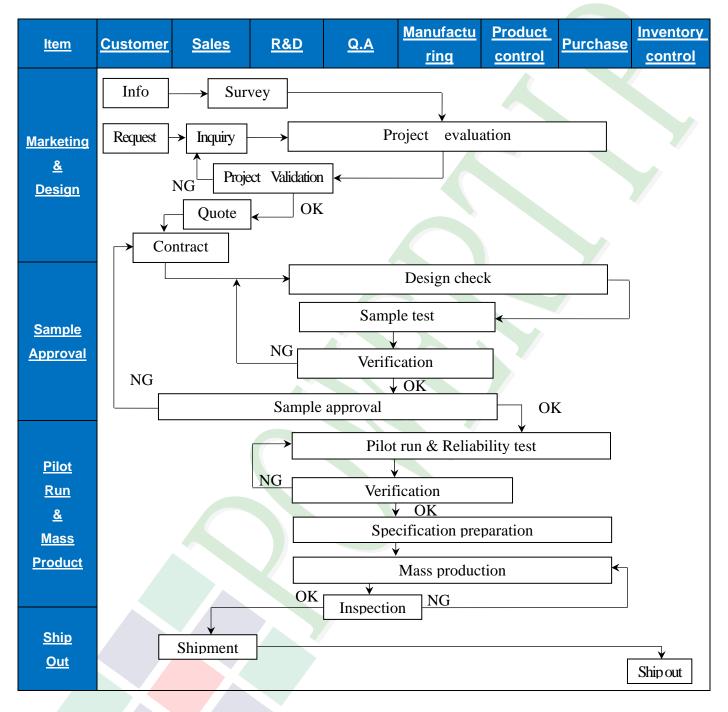
- f. Serial block operates with SCL clock.
- g. Serial data can be accepted in the power save mode.

h. After power on reset or GRB reset, it is required 100ms delay to begin SPI communication.



## 3. Quality Assurance System

## 3.1 Quality Assurance Flow Chart





<u>ltem</u>	<u>Customer</u>	<u>Sales</u>	<u>R&amp;D</u>	<u>Q.A</u>	<u>Manufactur</u> <u>ing</u>	Product control	Purchase	Inventory control
<u>Sales</u> Service	Info Analysis	Claim -		Trac	Failure a			
<u>Q.A</u> <u>Activity</u>	<ol> <li>ISO 9001 Maintenance Activities</li> <li>Process improvement proposal</li> <li>Equipment calibration</li> <li>Education And Training Activities</li> <li>Standardization Management</li> </ol>							

## **3.2 Inspection Specification**

Scope: The document shall be applied to TFT-LCD Module for 3. 5" -15" (Ver.B01).

◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

**•**Equipment: Gauge, MIL-STD, Powertip Tester, Sample

◆Defect Level: Major Defect AQL: 0. 4; Minor Defect AQL: 1.5

**OUT Going Defect Level: Sampling** 

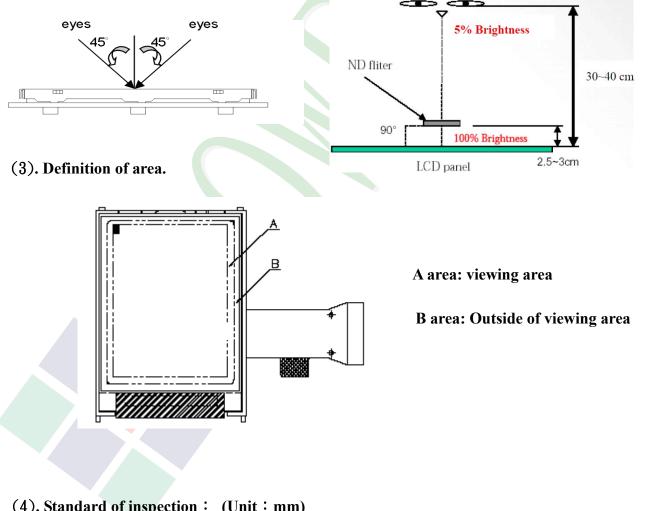
**•**Standard of the product appearance test:

a. Manner of appearance test:

(1). The test best be under 20W×2 fluorescent light(about 300lux ~500lux)

and distance of view must be at 30~40 cm.

(2). The test direction is base on about around 45° of vertical line.



(4). Standard of inspection : (Unit : mm)



#### ◆Specification For TFT-LCD Module 3. 5" ~15" :

cification For TFT-L	CD Module 3. 5"~15":	(Ver.B01)				
<u>Item</u>	Criterion					
	1.1 The part number is inconsistent with work order of production.					
01 <b>Product condition</b>	1. 2 Mixed product types.	Major				
	1. 3 Assembled in inverse direction.	Major				
Quantity	2.1 The quantity is inconsistent with work order of production.	Major				
Outline dimension	3.1 Product dimension and structure must conform to structure diagram.	Major				
	4. 1 Missing line character and icon.	Major				
Electrical Testing	4. 2 No function or no display.	Major				
	4. 3 Display malfunction.					
	4. 4 LCD viewing angle defect.					
	4. 5 Current consumption exceeds product specifications.					
	4. 6 Mura cannot be seen through 5% ND filter at 50% Gray, should be judged by the viewing angle of 90 degree.					
	ItemAcceptance (Q'ty)					
	Bright Dot ≤ 4					
Dot defect	<b>Dot</b> Dark Dot $\leq 5$					
	$\frac{\text{Defect}}{\text{Joint Dot}} \leq 3$					
	Total ≤ 7	Minor				
Dark dot)		MIIIOI				
On -display	5. 1 Inspection pattern: full white, full black, Red, Green and					
	<b>5. 4 Bright dot that can not be seen through 5% ND filter.</b>					
	Item         Product condition         Quantity         Outline dimension         Electrical Testing	Item         Criterion           Product condition         1.1 The part number is inconsistent with work order of production.           1.2 Mixed product types.         1.3 Assembled in inverse direction.           Quantity         2.1 The quantity is inconsistent with work order of production.           Outline dimension         3.1 Product dimension and structure must conform to structure diagram.           Quantity         4.1 Missing line character and icon.           4.2 No function or no display.         4.3 Display malfunction.           4.4 LCD viewing angle defect.         4.5 Current consumption exceeds product specifications.           4.6 Mura cannot be seen through 5% ND filter at 50% Gray, should be judged by the viewing angle of 90 degree.           Dot defect         Dot defect           (Bright dot, Dark dot)         Defect         Joint Dot         ≤ 3           Datk dot, Dark dot         5.1 Inspection pattern: full white, full black. Red. Green and				



<u>NO</u>	<u>Item</u>				<u>Crit</u>	<u>erion</u>			Level									
		6.1 R	6. 1 Round type (Non-display or display):															
			Dimension	n (diameter	<u>:Ф)</u>	<u>Accepta</u> <u>A area</u>	nce (Q'ty) B are											
				$\Phi \leq 0.2$	25	Ignore												
	Black or white		0.25	$< \Phi \leq 0.3$	50	5												
	Dot, scratch,			$\Phi > 0$	.50	0	- Igno	re										
	contamination			Total		5												
	Round type → <sub>X</sub> ←	6. 2 L	ine type(No	on-display (	or disp	lay):												
	$ \begin{array}{c}                                     $	m	odule size	Length (L)	W	<u>idth (W)</u>	Acceptant <u>A area</u>	ce (Q'ty) <u>B area</u>										
06						$W \leq 0.03$	Ignore		Mino									
	$\Phi = (x+y)/2$	<u>3.5" to less</u>		L ≦10.0	0.03	$<$ W $\leq$ 0.05	4											
	Line type ↓			L ≦5.0	0.05	$<$ W $\leq$ 0.10	2	Ignore										
			<u>9"</u>		<u>9"</u>				W > 0.10	As round	-9							
	│			Total			<u>type</u> 5	-										
							Ignore											
						L ≦10.0	0.05	$<$ W $\leq$ 0.10	5									
															<u>9" to 15"</u>			W > 0.10
					Total		1	type 5										
							-											
		D	imension (	diameter: <b>(</b>	<u>)</u>		tance (Q'ty											
				$\Phi \leq 0.25$		<u>A area</u> Ignore	<u> </u>	area										
07	Polarizer Bubble			$\Phi \leq 0.50$		4			Mino									
	Bubble		0.50 <	$\Phi \leq 0.80$				gnore										
				$\Phi > 0.80$		0												
			То	tal		5												



## ◆Specification For TFT-LCD Module 3. 5″~15″∶

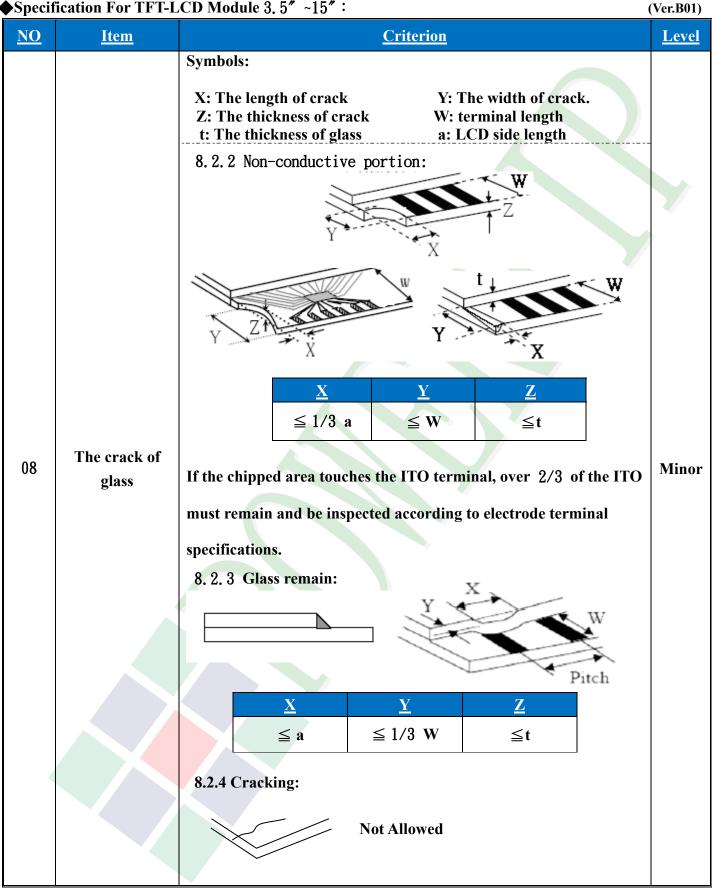
<u>0</u>	<u>Item</u>	Criterion		Level
		8	Y: The width of crack. W: terminal length a : LCD side length	
		8.1 General glass chip: 8.1.1 Chip on panel surface and c	rack between panels:	
		X Y Z	Z X X	
08	The crack of glass	SP Y (OK)	ING]	Mino
		Seal width	Y	
			<u>Z</u>	
		≤ a Crack can't enter viewing area	≦1/2 t	
		≤ a Crack can't exceed the half of SP width.	$1/2 t < Z \leq t$	



#### ◆Specification For TFT-LCD Module 3. 5″~15″: (Ver.B01) NO **Item Criterion** Level Symbols : Y: The width of crack. X: The length of crack **Z:** The thickness of crack W: terminal length t: The thickness of glass a: LCD side length 8.1.2 Corner crack: X Y Z Crack can't enter ≦1/5 a Z $\leq 1/2 t$ viewing area Crack can't exceed the $\leq 1/5$ a $1/2 t < Z \leq 2 t$ half of SP width. 08 The crack of glass Minor 8.2 Protrusion over terminal: 8.2.1 Chip on electrode pad: W $\underline{\mathbf{Z}}$ X Y $\leq 1/2 W$ ≦ t Front ≦ a W $\leq 1/2 t$ ≦ a $\leq$ Back



#### ◆Specification For TFT-LCD Module 3. 5″~15″:





#### ◆Specification For TFT-LCD Module 3. 5″~15″:

◆Specification For TFT-LCD Module 3. 5″~15″: (V							
<u>NO</u>	<u>Item</u>	<u>Criterion</u>	Level				
		9. 1 Backlight can't work normally.	Major				
09	Backlight elements	9. 2 Backlight doesn't light or color is wrong.	Major				
		9. 3 Illumination source flickers when lit.	Major				
		10.1 Pin type, quantity, dimension must match type in structure diagram.	Major				
	10. 2 No short circuits in components on PCB or FPC.	Major					
10	General	10. 3 Parts on PCB or FPC must be: no wrong parts, missing parts or excess parts.	Major				
10	appearance	10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor				
	10. 5 The folding and peeled off in polarizer are not acceptal	10. 5 The folding and peeled off in polarizer are not acceptable.	Minor				
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC ) is ≤1.5 mm.	Minor				



## 4. Reliability Test

# 4.1 Reliability Test Condition

(Ver.B01)

<u>NO.</u>	TEST ITEM	TEST CONDITION					
1	High Temperature Storage Test	Keep in 80 ±5°C 240 hrs					
2	Low Temperature Storage Test	Keep in −30 ±5°C 240 hrs					
3	High Temperature / High Humidity Storage Test	Keep in 60 $^{\circ}$ C / 90% R.H duration for 240 hrs (Excluding the polarizer)					
4	Temperature Cycling Storage Test	$ \begin{array}{r} -30^{\circ}\mathbb{C} \rightarrow +25^{\circ}\mathbb{C} \rightarrow 80^{\circ}\mathbb{C} \rightarrow +25^{\circ}\mathbb{C} \\ (30 \text{mins})  (5 \text{mins})  (30 \text{mins})  (5 \text{mins}) \\ \hline 20 \text{ Cycle} \end{array} $					
5	ESD Test	Air Discharge:Contact Discharge:Apply 2 KV with 5 timesApply 250 V with 5 timesDischarge for each polarity +/-discharge for each polarity +/-1. Temperature ambiance: 15°C ~35°C2. Humidity relative: 30% ~60%3. Energy Storage Capacitance(Cs+Cd): 150pF±10%4. Discharge Resistance(Rd): 330 Ω±10%5. Discharge, mode of operation:Single Discharge (time between successive discharges at least 1 sec)(Tolerance if the output voltage indication: ±5%)					
6	Vibration Test (Packaged)	<ol> <li>Sine wave 10~55 Hz frequency (1 min/sweep)</li> <li>The amplitude of vibration: 1.5 mm</li> <li>Each direction (X, Y, Z) duration for 2 hrs</li> </ol>					
7	Drop Test (Packaged)	Packing Weight (Kg)         Drop Height (cm)           0 ~ 45.4         122           45.4 ~ 90.8         76           90.8 ~ 454         61           0ver 454         46					

◎Result Evaluation Criteria :

Under the display quality test conditions with normal operations with normal operation state. Do not change these conditions as such changes may affect practical display function. (Normal operation state) Temperature : +20~30°C Humidity : 50~70% Atmospheric pressure : 86~106Kpa



# 5. Precaution Relating Product Handling

### 5.1 Safety

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

## 5.2 Handling

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers ,etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is  $320 \pm 10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM
- 5.2.10 Caution! ( LCM products with Capacitive Touch Panel)

Strong EMI-sources such as switch-mode power supplies (SMPS) can lead to touch malfunction (e.g. ghost-touches).

Therefore, the touch needs to be thoroughly tested inside the target application.

5.2.11 Caution: Continuously displaying same static image will result in high possibility of image sticking/image burn-in effect due to TFT panel characteristic.

#### 5.3 Storage

- 5.3.1 Store the panel or module in a dark place where the temperature is  $25^{\circ}C \pm 5^{\circ}C$  and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

### 5.4 Terms of Warranty

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

